

Product Specification - Dec 20, 2002 V.03 Supersedes Date of Jun. 04, 2002



CHIP RESISTORS ARRAY YC124 (8Pin/4R) 5%; 1%

Innovative Service Around the Globe







Chip Resistor Surface Mount YC SERIES 124

SCOPE

This specification describes YCI24 series chip resistors made by thick film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing style, temperature coefficient, special type and resistance value.

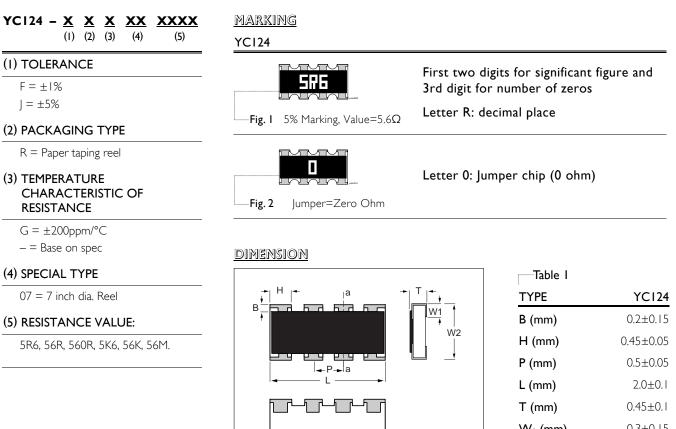


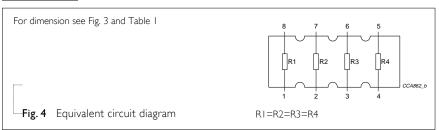
Fig. 3 YCI24 series chip resistors construction

CCB257_a

TYPE	YCI24
B (mm)	0.2±0.15
H (mm)	0.45±0.05
P (mm)	0.5±0.05
L (mm)	2.0±0.1
T (mm)	0.45±0.1
W⊤ (mm)	0.3±0.15
W ₂ (mm)	1.0±0.1
H ₂ (mm)	0.3±0.05

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SCHEMATIC

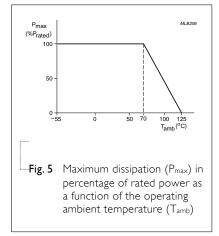


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POWER RATING

RATED POWER AT 70°C, YC124=1/16W FOR ELEMENT



RATED VOLTAGE:

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

 $V=\sqrt{(P X R)}$

Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)

ELECTRICAL CHARACTERISTICS

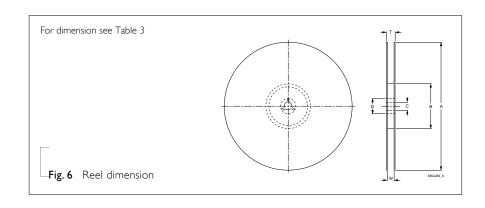
Table 2	
CHARACTERISTICS	YC124 I/16W
Operating Temperature Range	–55°C to +125°C
Maximum Working Voltage	50V
Maximum Overload Voltage	100V
Dielectric Withstanding Voltage	100V
Number of Resistors	4
Resistance Range	10Ω to 1MΩ
Temperature Coefficient	±200ppm/°C



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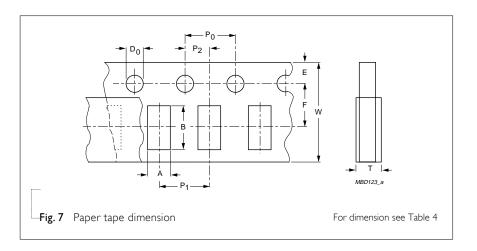
<u>TAPING REEL</u>

Table 3	
DIMENSION	YC124
Tape Width	8mm
ØA (mm)	180+0/-3
ØB (mm)	60+1/_0
ØC (mm)	13.0±0.2
ØD (mm)	21±0.8
W (mm)	9.0±0.3
T _{max} (mm)	.4±



PAPER TAPE SPECIFICATION

Table 4	
DIMENSION	YCI24
A (mm)	1.2±0.1
B (mm)	2.2±0.1
W (mm)	8.0±0.2
E (mm)	1.75±0.1
F (mm)	3.5±0.05
P₀ (mm)	4.0±0.1
P₁ (mm)	2.0±0.1
P ₂ (mm)	2.0±0.05
ØD₀ (mm)	1.5+0.1/-0
T _{max} (mm)	0.70±0.1



PACKING METHOD

LEADER/TRAILER TAPE SPECIFICATION

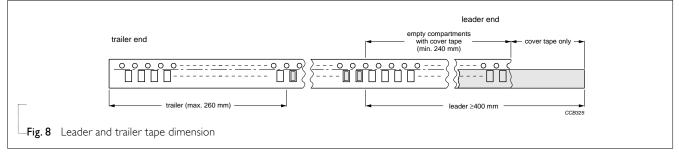


Table 5 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	YCI24
Paper Taping Reel (R)	7" (178 mm)	10,000



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TYPE	TEST METHOD		ACCEPTANCE STANDARI
Temperature Coefficient of Resistance (T.C.R.)	Measure resistance at +25°C or specified room temperature as R1, then measure at -55°C or +125°C respectively as R2.FormulaDetermine the temperature coefficient of resistance from the following formula:T.C.R = $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$ Where t_1=+25°C or specified room temperature t_2=-55°C or +125°C test temperature 		Refer to table 2
Thermal Shock	cycles, the specimen shall be sta	at +125±2°C for 2 minutes as one cycle. After 5 bilized at room temp. mine Δ R/R(%) after one more hour.	5 ±(1%+0.05Ω)
Low Temperature Operation	Place the specimen in a test chamber maintained at $-65 (+0/-5)^{\circ}$ C. After one hour stabilization at this temperature, full rated working voltage shall be applied for 45 (+5/-0) minutes. Have 15 (+5/-0) minutes after remove the voltage, the specimen shall be removed from the chamber and stabilized at room temperature for 24 hrs. Measure the resistance to determine $\Delta R/R(\%)$.		No visible damage
Short Time Overload		but not exceeding the maximum overload volta en stabilized at room temperature for 30 minute mine Δ R/R(%).	-
Insulation Resistance	Place the specimen in the jig an continues overload voltage (R.C minute as shown. Measure the insulation resistance	COV) for one Voltage	124 ≥10,000MΩ 00V
Dielectric Withstand Voltage	Place the specimen in the jig an specified value continuous over shown for one minute.	oad voltage as	I24Breakdown voltage>oovspecification and withoutopen/short
Resistance To Soldering Heat		older pot at 260±5°C. for 10±1 seconds. Have the pot at 260±5°C for 10±1 seconds. Have the potential of the	he ±(1.0%+0.05Ω) No visible damage

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TYPE	TEST METHOD	ACCEPTANCE STANDARD
Moisture Resistance	Place the specimen in the test chamber and subject to 42 damp heat cycles. Each one of which consists of the steps 1 to 7 as figure 10. The total length of test is 1,000 hours. Have the specimen stabilized at room temperature for 24 hours after testing.	±(2.0%+0.05Ω) No visible damage
Life	Measure the resistance to determine $\Delta R/R(\%)$. Place the specimen in the oven at 70±2°C. Apply the rated voltage to the specimen at the 1.5 hours on and 0.5 hour off cycle. The total length of test is 1,000 hours. Have the specimen stabilized at room temperature for one hour minimum after testing.	±(3%+0.1Ω) for 5% tolerance No visible damage
Solderability	Measure the Δ R/R(%). Immerse the specimen in the solder pot at 230±5°C for 5 sec.	At least 95% solder coverage on the termination
Bending Strength	Mount the specimen on a test board as shown in the figure 9. Slowly apply the force till the board is bent for 5 ± 1 sec. Measure the $\Delta R/R(\%)$ at this position.	±(1.0%+0.05Ω) No visible damage

